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File: howland_ipump.sch

Title:

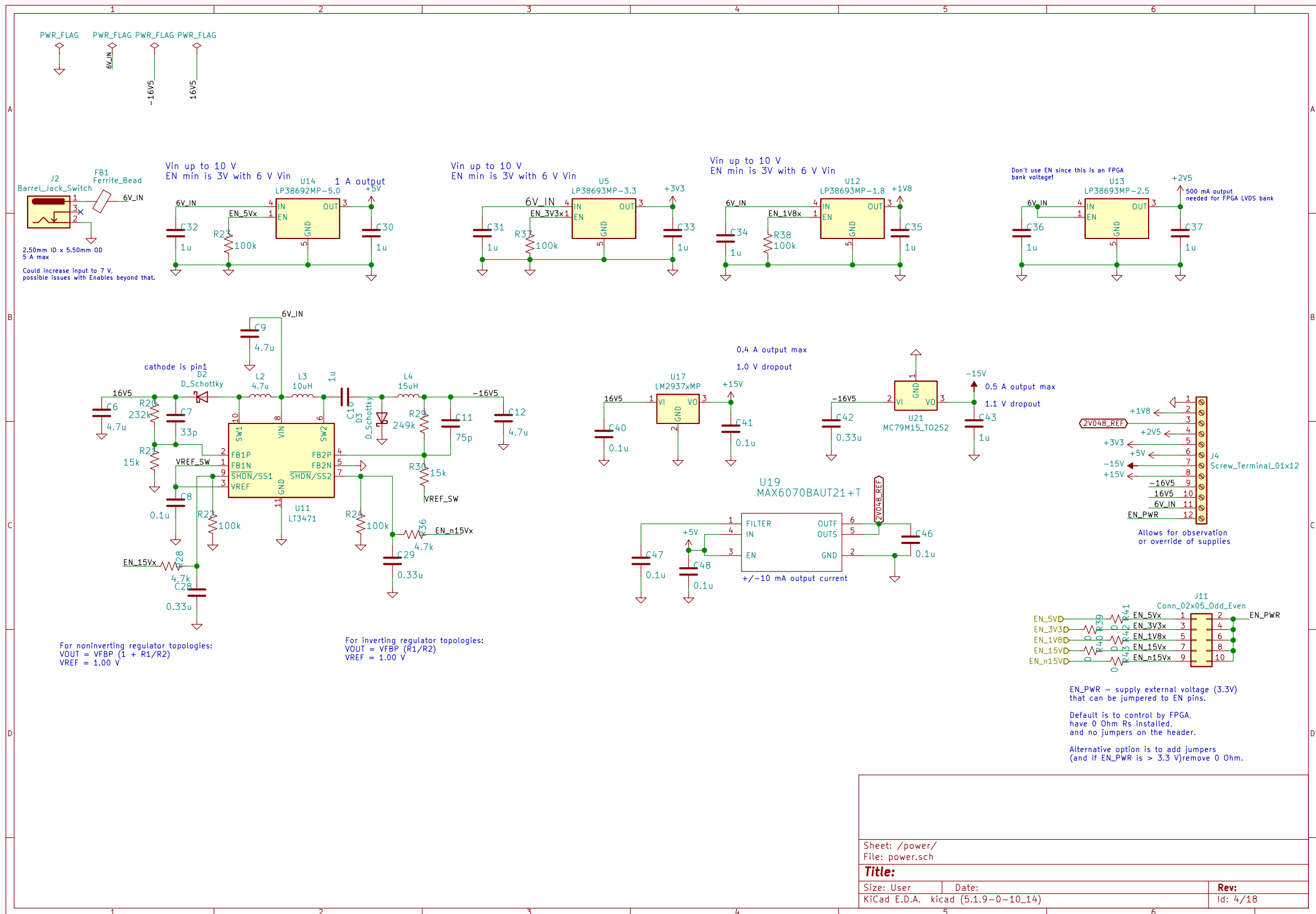
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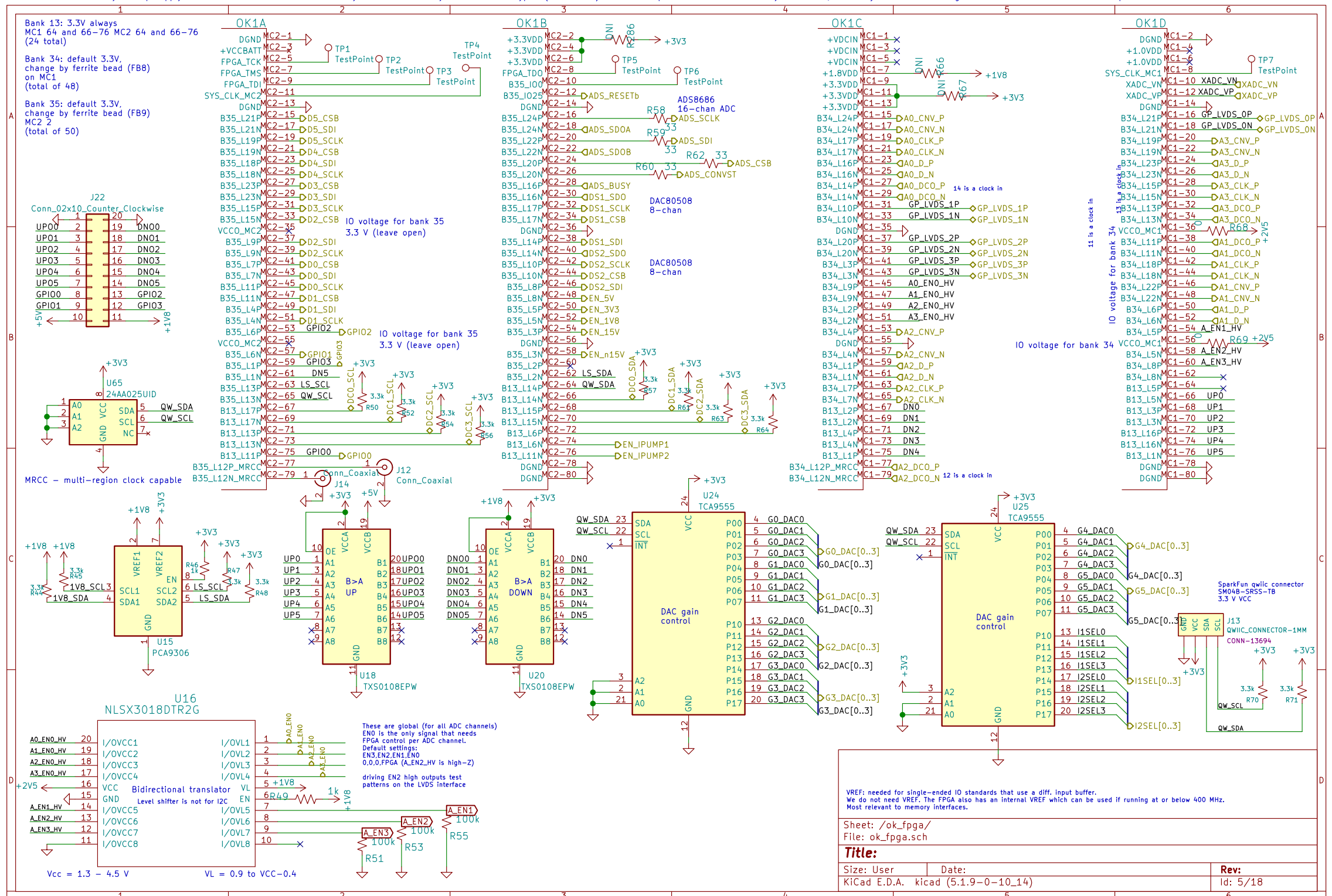
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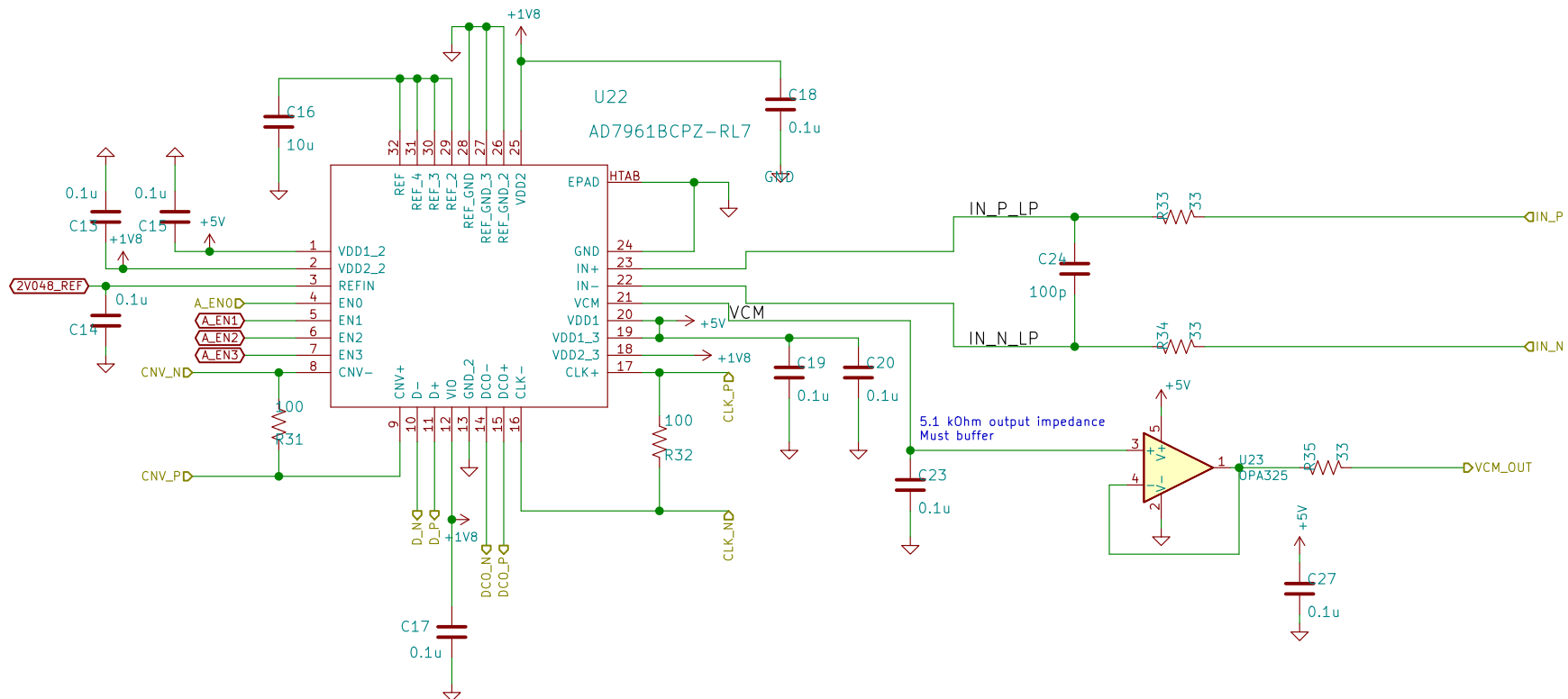
Id: 3/18



FPGA power: standard "canon-style" 2.1mm / 5.5mm jack. The outer ring is connected to DGND. The center pin is connected to +VDC.



Use internal buffer (x2) with 2.048V ref.
 "External reference of 2.048 V applied to the REFIN pin
 (high impedance input). The on-chip buffer gains this by 2
 and drives the REF pin with 4.096 V"
 EN3=X, EN2=0, EN1=0, EN0=1 (28 MHz BW)
 EN3=X, EN2=1, EN1=0, EN0=1 (9 MHz BW, use this BW only when the throughput is 2 MSPS or lower)
 VDD2 and VIO can come from the same supply.
 But route and decouple separately.

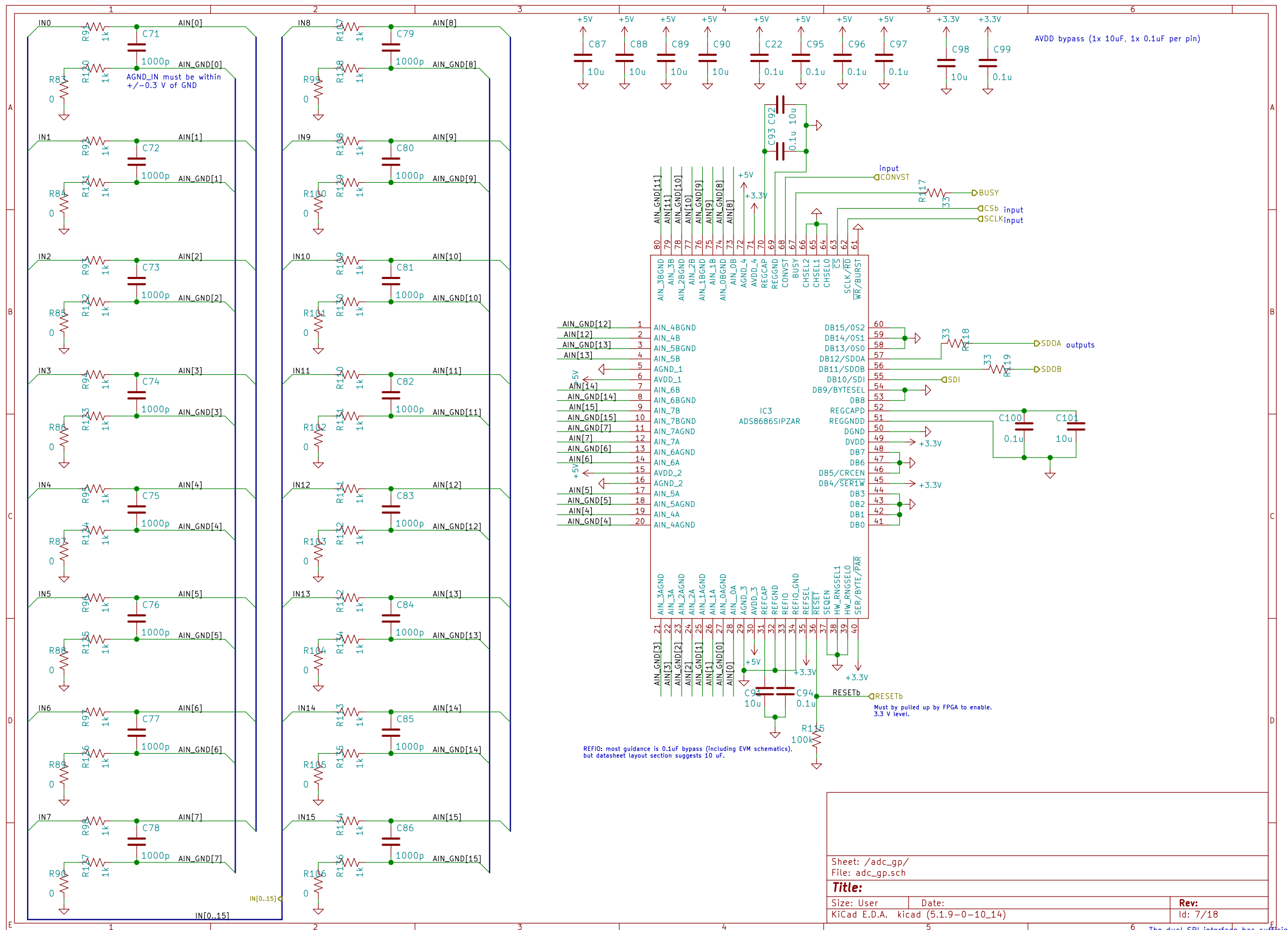


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Rev:
 Id: 6/18



AVDD bypass (1x 10uF, 1x 0.1uF per pin)

AIN_GND[12]	1	AIN_4BGND
AIN[12]	2	AIN_4B
AIN_GND[13]	3	AIN_5BGND
AIN[13]	4	AIN_5B
AIN[14]	5	AGND_1
AIN_GND[14]	6	AVDD_1
AIN[15]	7	AIN_6B
AIN_GND[15]	8	AIN_6BGND
AIN[15]	9	AIN_7B
AIN_GND[15]	10	AIN_7BGND
AIN_GND[7]	11	AIN_7AGND
AIN[7]	12	AIN_7A
AIN_GND[6]	13	AIN_6AGND
AIN[6]	14	AIN_6A
AIN[5]	15	AVDD_2
AIN_GND[5]	16	AGND_2
AIN[4]	17	AIN_5A
AIN_GND[4]	18	AIN_5AGND
AIN_GND[4]	19	AIN_4A
AIN_GND[4]	20	AIN_4AGND

REFIO: most guidance is 0.1uF bypass (including EVM schematics), but datasheet layout section suggests 10 uF.

Must be pulled up by FPGA to enable. 3.3 V level.

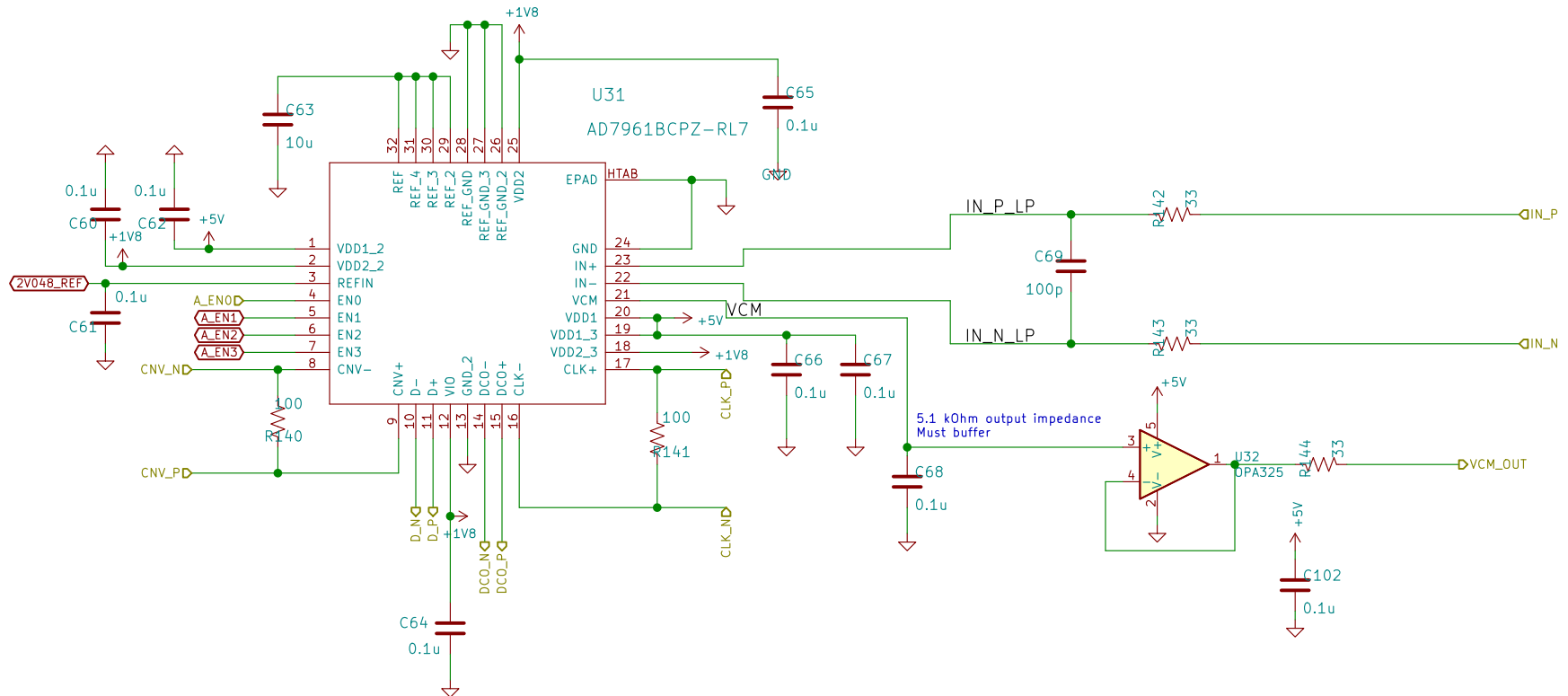
The dual SPI interface has sufficient BW to clock the data out at the 1 MSPS (just need 16 MHz clock rate)

A



2

Use internal buffer (x2) with 2.048V ref.
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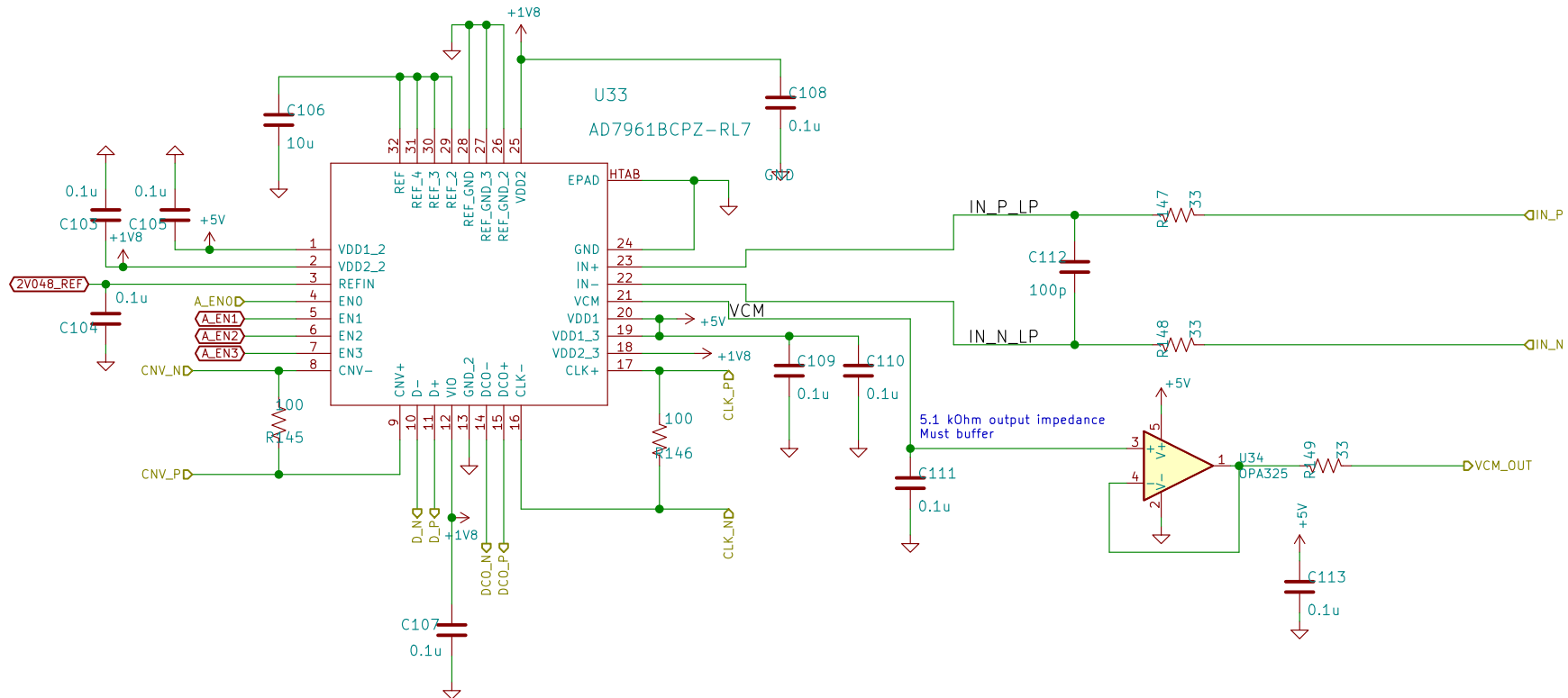
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Rev:
 Id: 9/18

Use internal buffer (x2) with 2.048V ref.
 "External reference of 2.048 V applied to the REFIN pin
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 EN3=X, EN2=0, EN1=0, EN0=1 (28 MHz BW)
 EN3=X, EN2=1, EN1=0, EN0=1 (9 MHz BW, use this BW only when the throughput is 2 MSPS or lower)
 VDD2 and VIO can come from the same supply.
 But route and decouple separately.

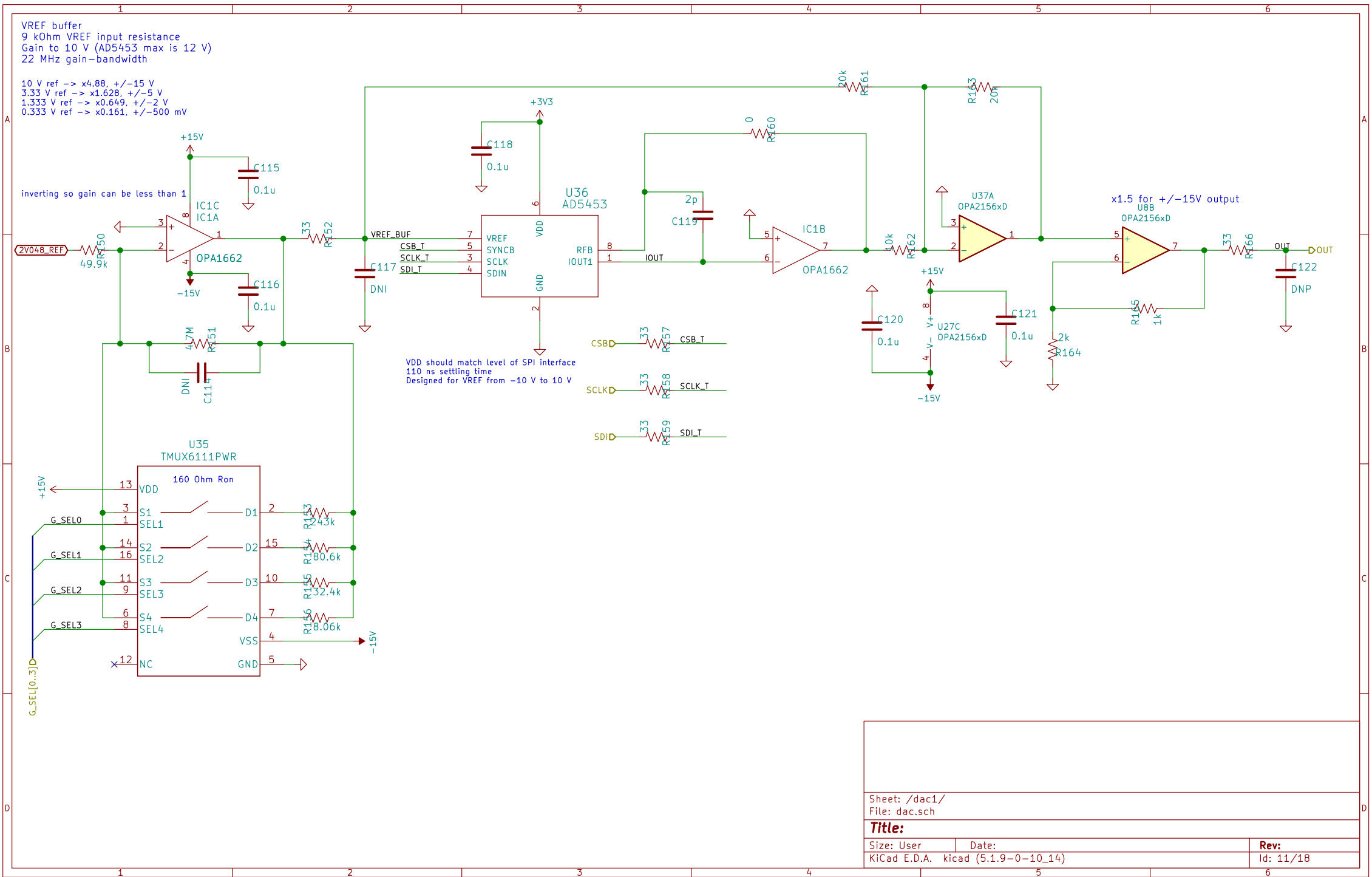


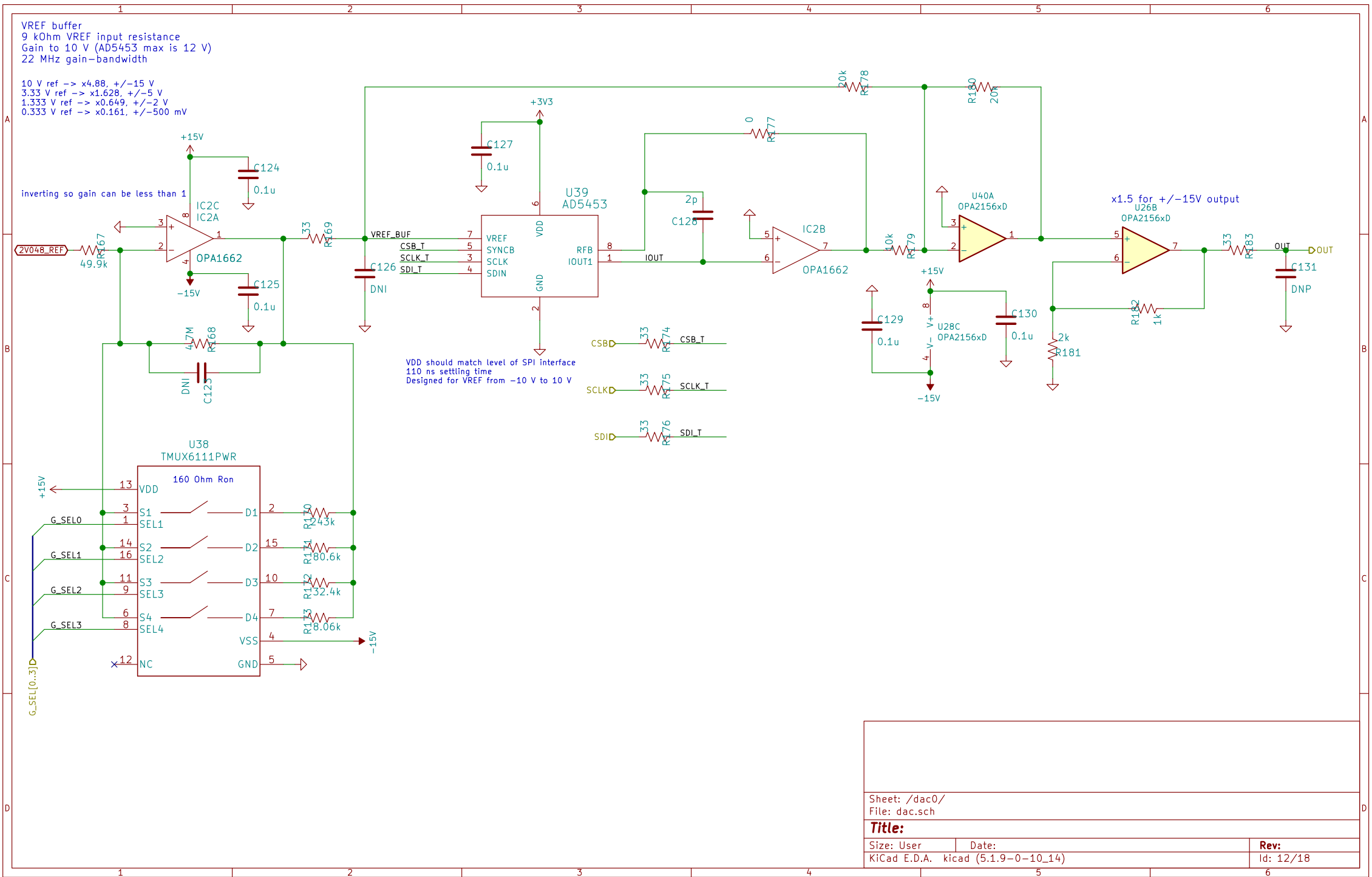
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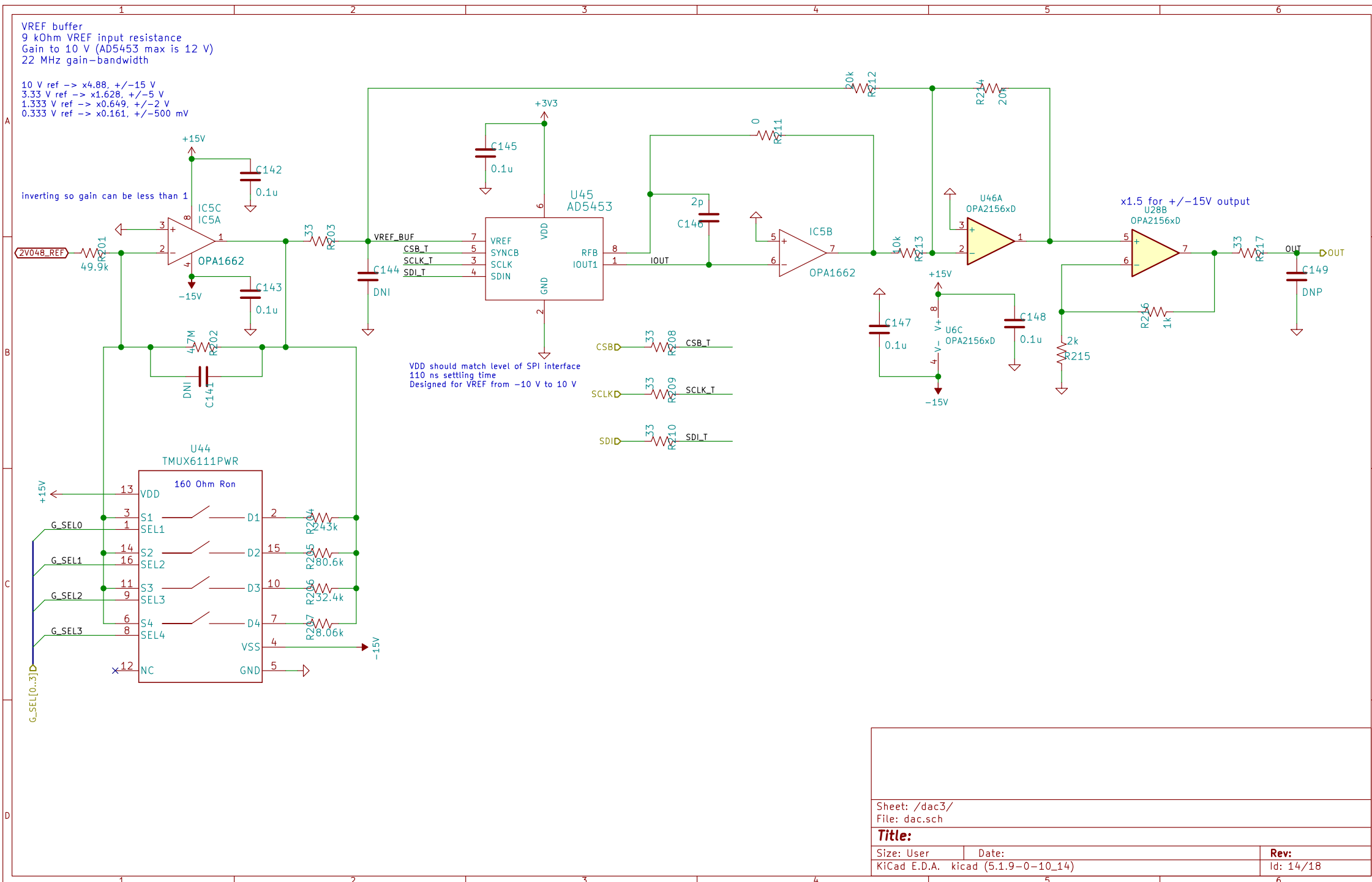
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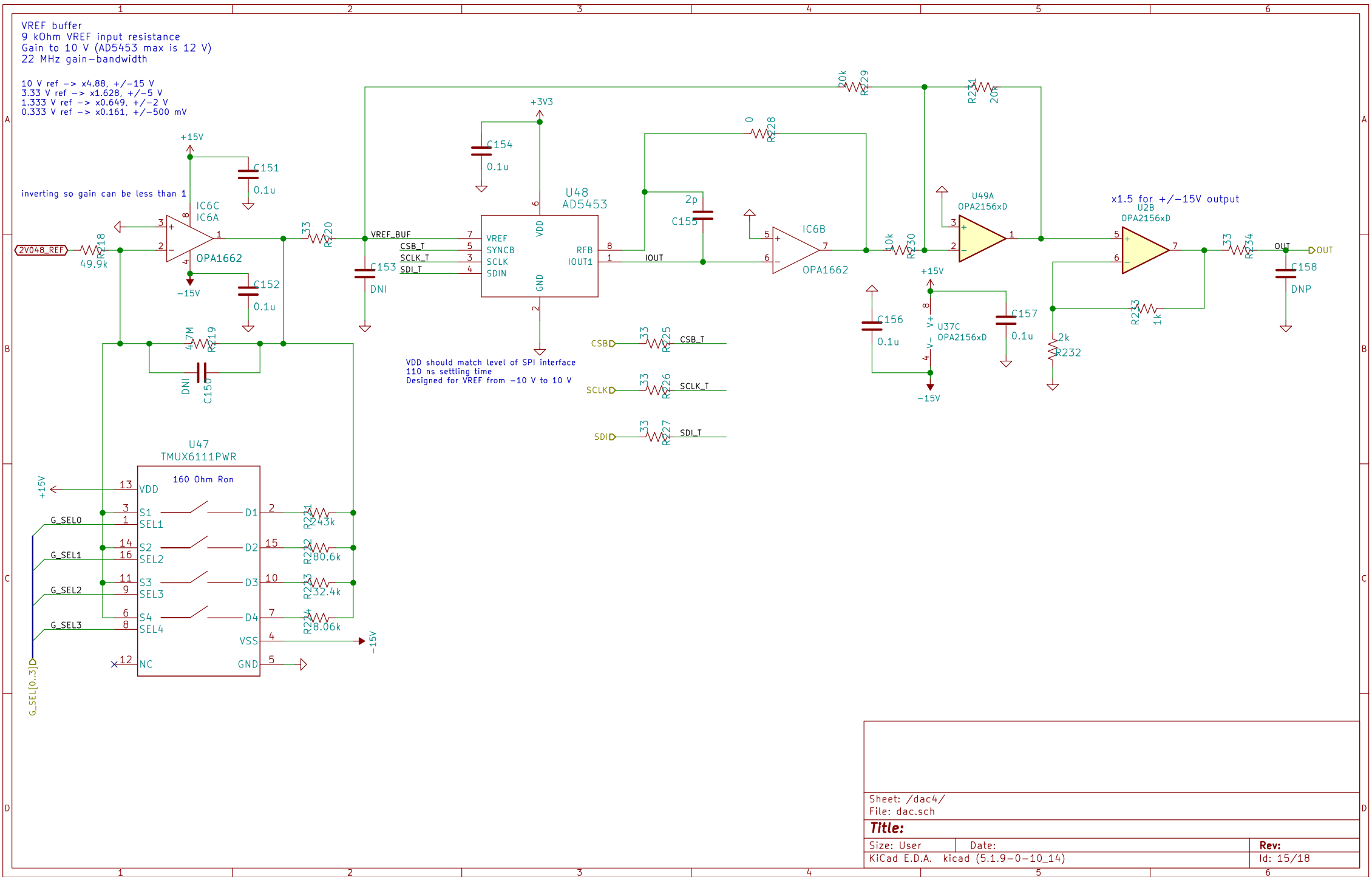
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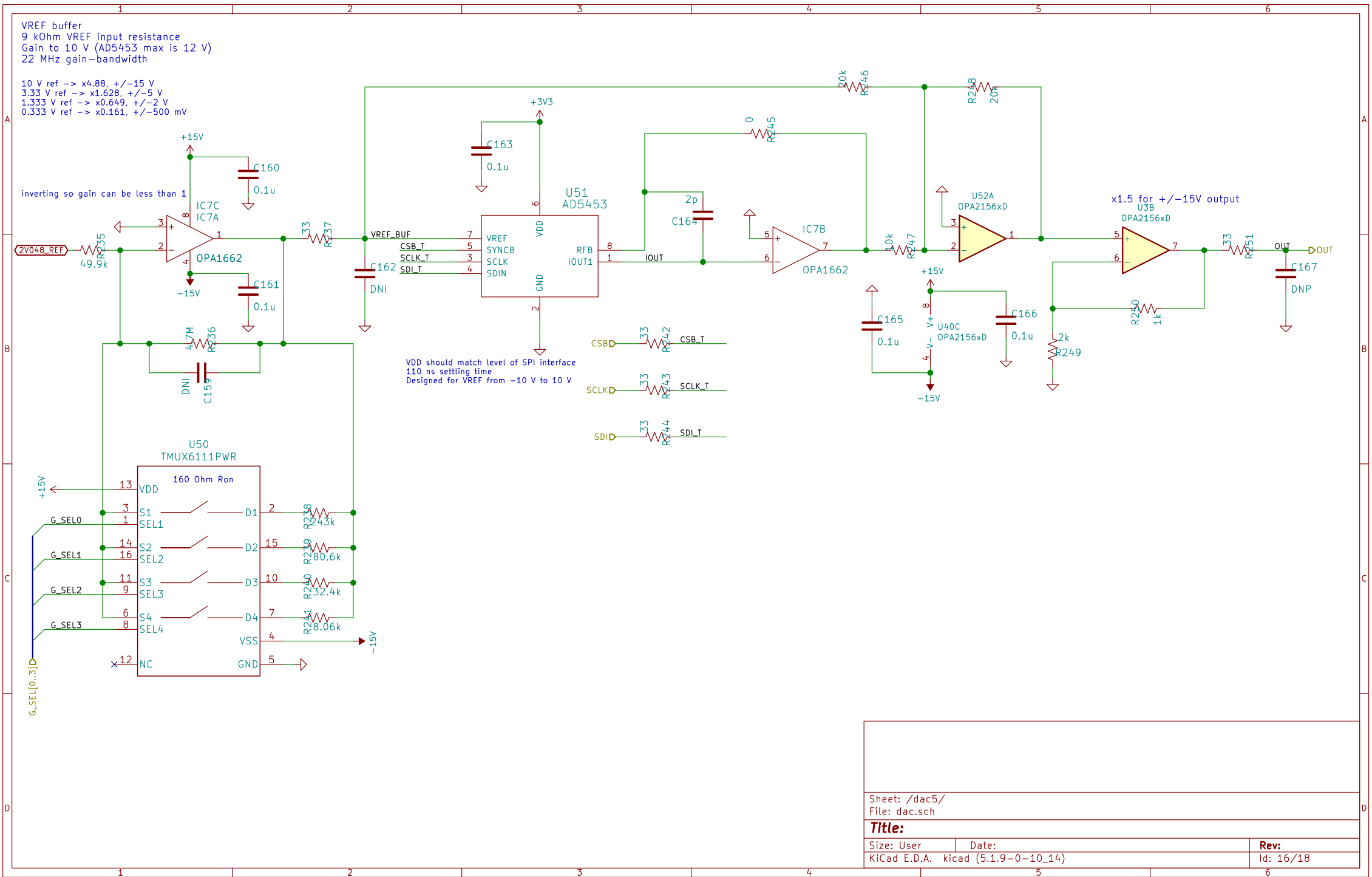
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 Id: 10/18

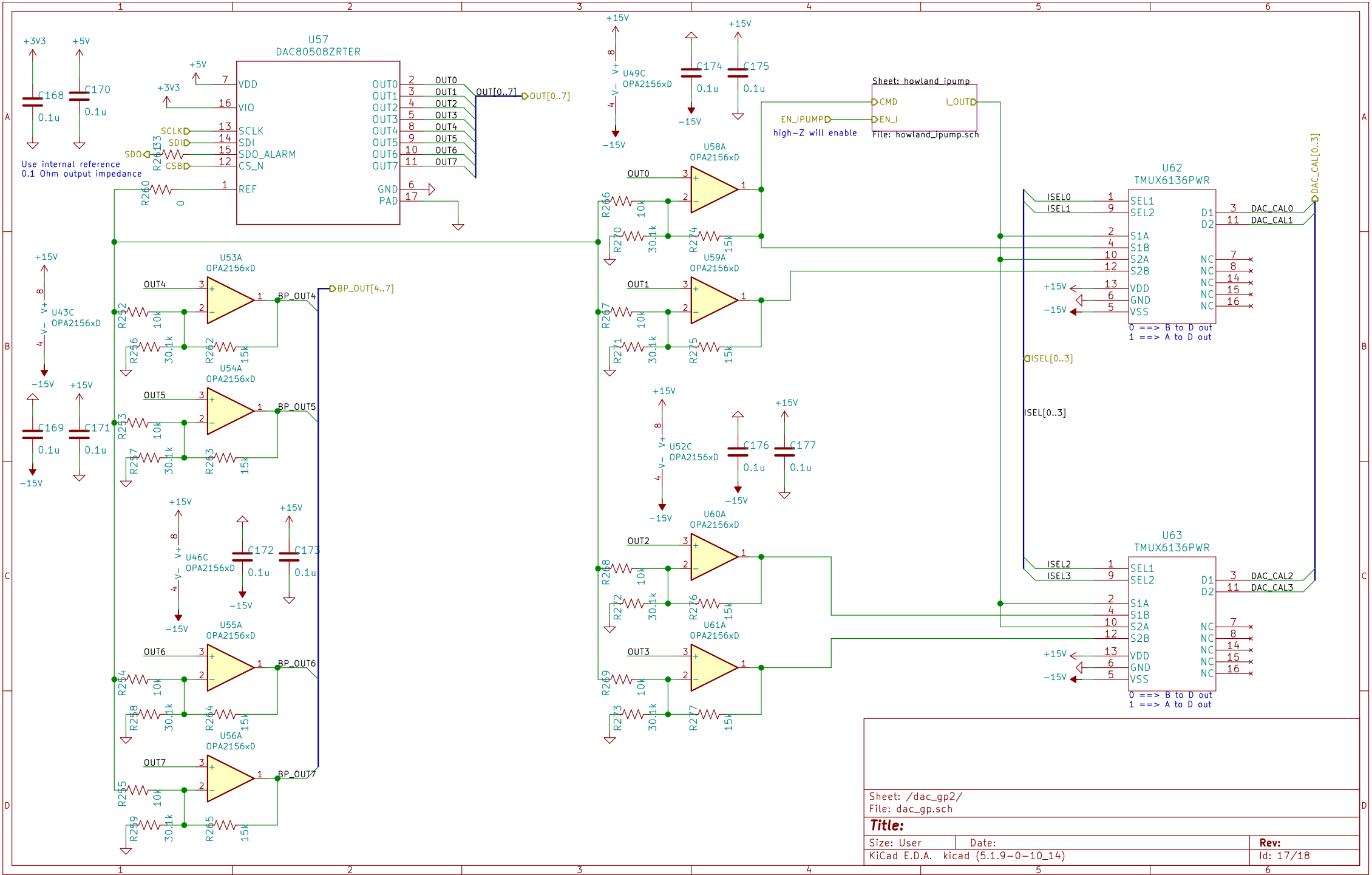


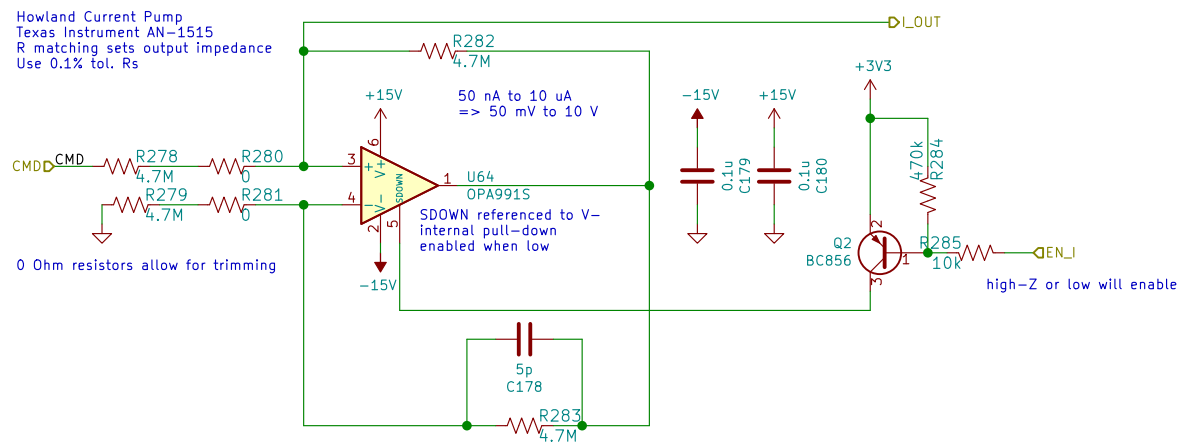












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Id: 18/18